Electronic Patent Application Fee Transmittal							
Application Number:	10516455						
Filing Date:	03-Dec-2004						
Title of Invention:	Method and device for substrate etching with very high power inductively coupled plasma						
First Named Inventor/Applicant Name:	Michel Puech						
Filer:	Brian Kenneth Shelton/Lynette Mansfield						
Attorney Docket Number:	Q84452						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 2 months with \$0 paid		1252	1	450	450		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			450